L Number	Hits	Search Text	DB	Time stamp
1	14	("4775281"|"5566466"|"5700046"|"5851041"|"6082946"|"6084726"|"6087604"|"6370968".PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/18 09:55
2	31	(("4308586") or ("4328553") or ("4475122") or ("4516855") or ("4555767") or ("4585348") or ("4618262") or ("4647207") or ("4653924") or ("4681450") or ("4713140") or ("4815856") or ("4826321") or ("4842410")).PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/18 09:01
3	3739	wafer with buffer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/18 09:24
4	1413429	semiconductor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/18 09:25
5	3086	(wafer with buffer) and semiconductor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/18 09:25
6	110803	robot robotics	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/18 09:25
7	383	((wafer with buffer) and semiconductor) and (robot robotics)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/18 09:45
8	7464	metrology	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/18 09:26
9	59	(((wafer with buffer) and semiconductor) and (robot robotics)) and metrology	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/18 09:26
12	1	6212961.URPN.	USPAT	2004/10/18 09:44
13	324	(((wafer with buffer) and semiconductor) and (robot robotics)) not ((((wafer with buffer) and semiconductor) and (robot robotics)) and metrology)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/18 09:47
14	17	"5957648"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/18 09:47